


MITSUBISHI INSULATED GATE BIPOLAR TRANSISTOR

CT20VS-8

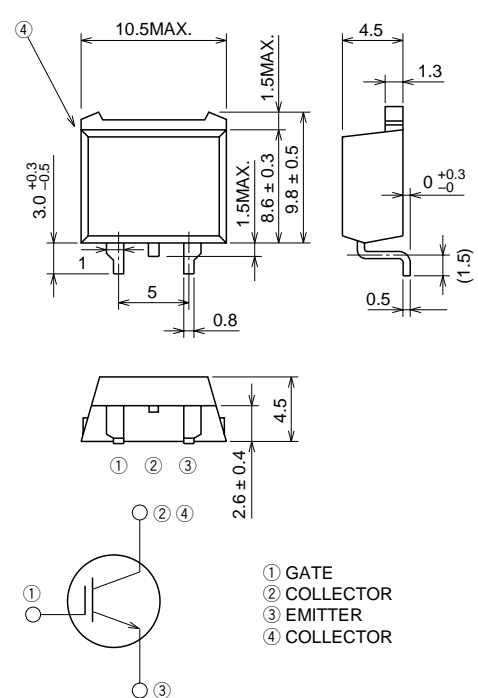
STROBE FLASHER USE

CT20VS-8



• V_{CES} 400V
 • I_{CM} 130A

OUTLINE DRAWING Dimensions in mm



① GATE
② COLLECTOR
③ EMITTER
④ COLLECTOR

TO-220S

APPLICATION
Strobe Flasher.

MAXIMUM RATINGS ($T_c = 25^\circ\text{C}$)

| Symbol | Parameter | Conditions | Ratings | Unit |
|-----------|----------------------------|------------------------------|-----------------|------------------|
| V_{CES} | Collector-emitter voltage | $V_{GE} = 0V$ | 400 | V |
| V_{GES} | Gate-emitter voltage | $V_{CE} = 0V$, See notice 4 | ± 30 | V |
| V_{GEM} | Peak gate-emitter voltage | $V_{CE} = 0V$, $t_w = 0.5s$ | ± 40 | V |
| I_{CM} | Collector current (Pulsed) | See figure 1 | 130 | A |
| T_j | Junction temperature | | $-40 \sim +150$ | $^\circ\text{C}$ |
| T_{stg} | Storage temperature | | $-40 \sim +150$ | $^\circ\text{C}$ |

ELECTRICAL CHARACTERISTICS ($T_j = 25^\circ\text{C}$)

| Symbol | Parameter | Test conditions | Limits | | | Unit |
|---------------|-------------------------------------|------------------------------------|--------|------|-----------|---------------|
| | | | Min. | Typ. | Max. | |
| $V_{(BR)CES}$ | Collector-emitter breakdown voltage | $I_C = 1mA$, $V_{GE} = 0V$ | 450 | — | — | V |
| I_{CES} | Collector-emitter leakage current | $V_{CE} = 400V$, $V_{GE} = 0V$ | — | — | 10 | μA |
| I_{GES} | Gate-emitter leakage current | $V_{GE} = \pm 40V$, $V_{CE} = 0V$ | — | — | ± 0.1 | μA |
| $V_{GE(th)}$ | Gate-emitter threshold voltage | $V_{CE} = 10V$, $I_C = 1mA$ | — | — | 7.0 | V |

PERFORMANCE CURVES

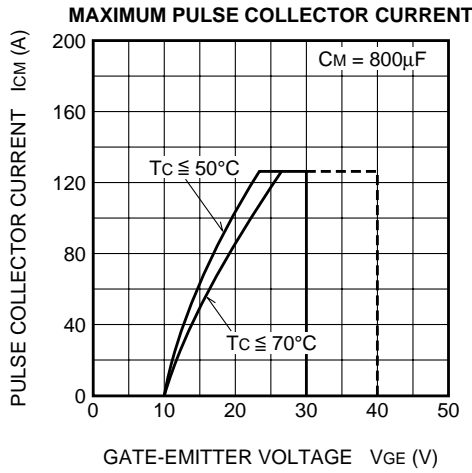


Figure 1

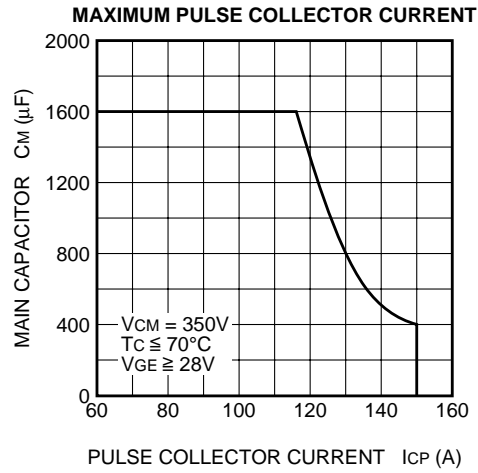
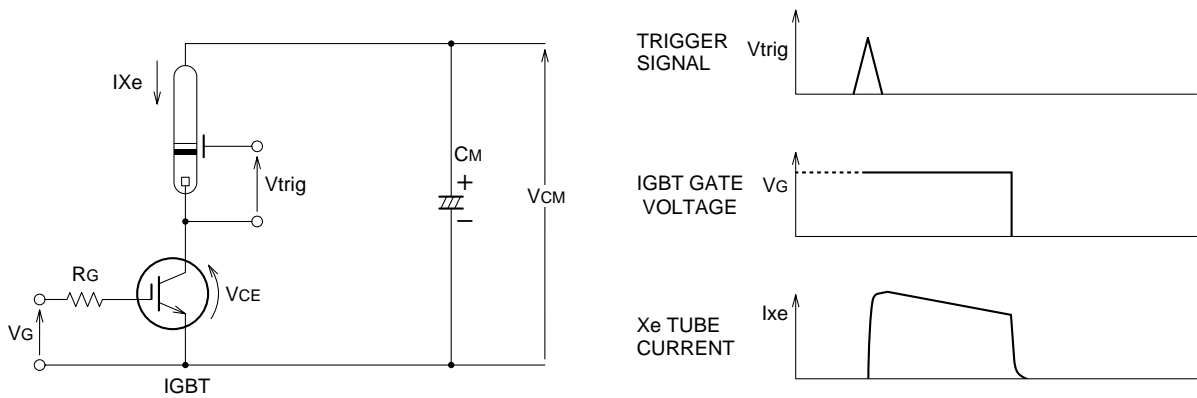


Figure 2

APPLICATION EXAMPLE



| RECOMMEND CONDITION | MAXIMUM CONDITION |
|------------------------|-------------------|
| V _{CM} = 330V | 360V |
| I _P = 120A | 130A |
| C _M = 700µF | 800µF |
| V _{GE} = 28V | |

- Notice 1. Gate drive voltage during on-period must be applied to satisfy the rating of maximum pulse collector current. And reverse gate current during turn-off must be kept less than 1A. (In general, it is satisfied if R_G ≥ 30Ω)
- Notice 2. IGBT has MOS structure and its gate is insulated by thin silicon oxide. So please handle carefully not to suffer from electrostatic charge.
- Notice 3. The operation life should be endured 5,000 shots under the charge current (I_{Xe} ≤ 130A : full luminescence condition) of main condenser (C_M=800µF). Repetition period under full luminescence condition is over 3 seconds.
- Notice 4. Total operation hours must be applied within 5,000 hours.